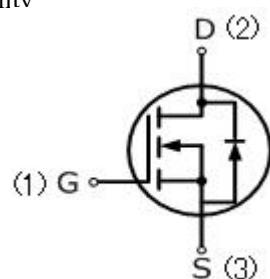


10N50TF

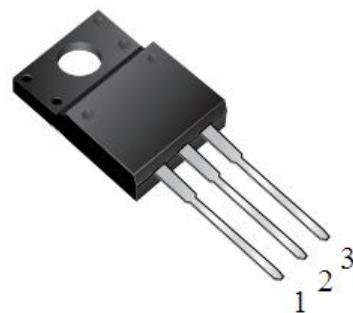
10 Amps, 500 Volts N-CHANNEL Power MOSFET

FEATURE

- 10A, 500V, $R_{DS(ON)}\text{MAX}=0.75 \Omega$ @ $V_{GS}=10V/5A$
- Low gate charge
- Low C_{iss}
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- Halogen free



TO-220TF



Absolute Maximum Ratings ($T_c=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	10N50TF	UNIT
Drain-Source Voltage	V_{DSS}	500	V
Gate-Source Voltage	V_{GSS}	± 30	
Continuous Drain Current	I_D	10	A
Pulsed Drain Current (Note 1)	I_{DM}	40	
Single Pulse Avalanche Energy (Note 2)	E_{AS}	580	mJ
Reverse Diode dV/dt (Note 3)	dv/dt	5	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	260	°C
Mounting Torque	6-32 or M3 screw	10	lbf • in
		1.1	N • m

Parameter	Symbol	10N50TF	Units
Thermal resistance, Channel to Case	$R_{th(ch-c)}$	3.13	°C/W
Thermal resistance, Channel to Ambient	$R_{th(ch-a)}$	62.5	°C/W
Maximum Power Dissipation	$T_c=25^\circ\text{C}$	40	W

Electrical Characteristics ($T_c=25^\circ\text{C}$, unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\text{uA}$	500	—	—	V
Breakdown Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Reference to 25°C , $\text{I}_D=250\text{uA}$	—	0.6	—	$\text{V}/^\circ\text{C}$
Zero Gate Voltage Drain Current	I_{DS}	$\text{V}_{\text{DS}}=500\text{V}, \text{V}_{\text{GS}}=0\text{V}$	—	—	1	uA
Gate-Body Leakage Current, Forward	I_{GSSF}	$\text{V}_{\text{GS}}=30\text{V}, \text{V}_{\text{DS}}=0\text{V}$	—	—	100	nA
Gate-Body Leakage Current, Reverse	I_{GSSR}	$\text{V}_{\text{GS}}=-30\text{V}, \text{V}_{\text{DS}}=0\text{V}$	—	—	-100	nA
On Characteristics						
Gate-Source Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\text{uA}$	2	—	4	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS(on)}}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=5\text{A}$	—	0.5	0.75	Ω
Dynamic Characteristics						
Input Capacitance	C_{iss}	$\text{V}_{\text{DS}}=25\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $f=1.0\text{MHz}$	—	1620	—	pF
Output Capacitance	C_{oss}		—	154	—	pF
Reverse Transfer Capacitance	C_{rss}		—	8.4	—	pF
Switching Characteristics						
Turn-On Delay Time	$t_{\text{d(on)}}$	$\text{V}_{\text{DD}}=250\text{V}, \text{I}_D=10\text{A},$ $\text{R}_G=10\Omega$ (Note 3,4)	—	26	—	ns
Turn-On Rise Time	t_r		—	20	—	ns
Turn-Off Delay Time	$t_{\text{d(off)}}$		—	52	—	ns
Turn-Off Fall Time	t_f		—	21	—	ns
Total Gate Charge	Q_g	$\text{V}_{\text{DS}}=400\text{V}, \text{I}_D=10\text{A},$ $\text{V}_{\text{GS}}=10\text{V}$, (Note 3,4)	—	32	—	nC
Gate-Source Charge	Q_{gs}		—	7.9	—	nC
Gate-Drain Charge	Q_{gd}		—	12	—	nC
Drain-Source Body Diode Characteristics and Maximum Ratings						
Continuous Diode Forward Current	I_s	$\text{I}_s=10\text{A}, \text{V}_{\text{GS}}=0\text{V}$	—	—	10	A
Pulsed Diode Forward Current	I_{SM}		—	—	40	A
Diode Forward Voltage	V_{SD}		—	—	1.5	V
Reverse Recovery Time	t_{rr}		—	411	—	ns
Reverse Recovery Charge	Q_{rr}		$d\text{I}_F/dt=100\text{A/us}$, (Note 4)	—	2.588	uC

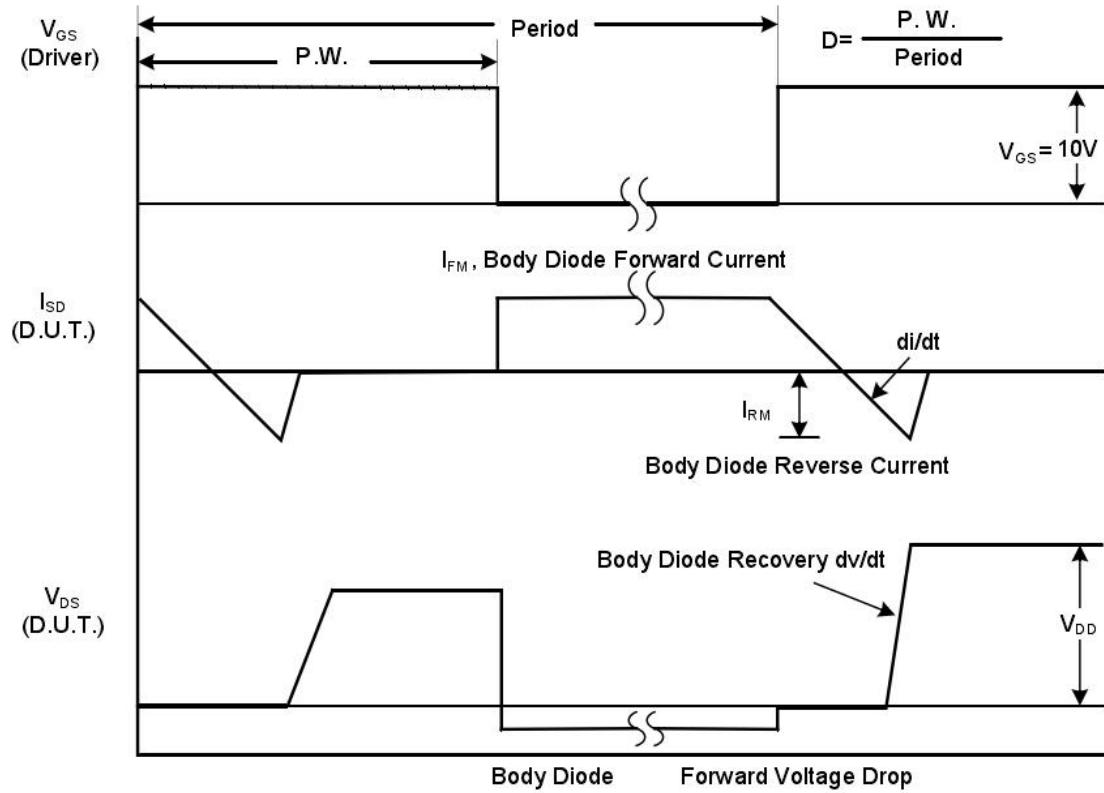
Notes

- Repetitive Rating: pulse width limited by maximum junction temperature.
- $L=10\text{mH}, \text{I}_{\text{AS}}=10.8\text{A}$, starting $T_J=25^\circ\text{C}$.
- $\text{I}_{\text{SD}}=10\text{A}, d\text{I}/dt \leq 100\text{A/us}, \text{V}_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, starting $T_J=25^\circ\text{C}$, Pulse width $\leq 300\text{us}$; duty cycle $\leq 2\%$.
- Repetitive rating; pulse width limited by maximum junction temperature.

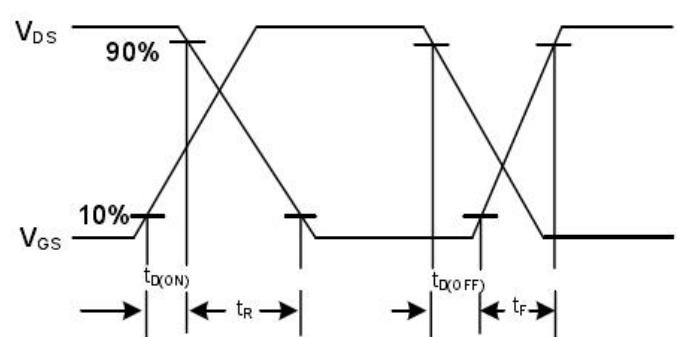
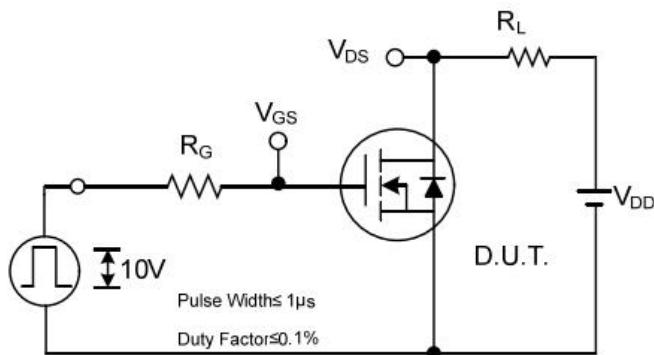
TEST CIRCUIT AND WAVEFORM



Peak Diode Recovery dv/dt Test Circuit

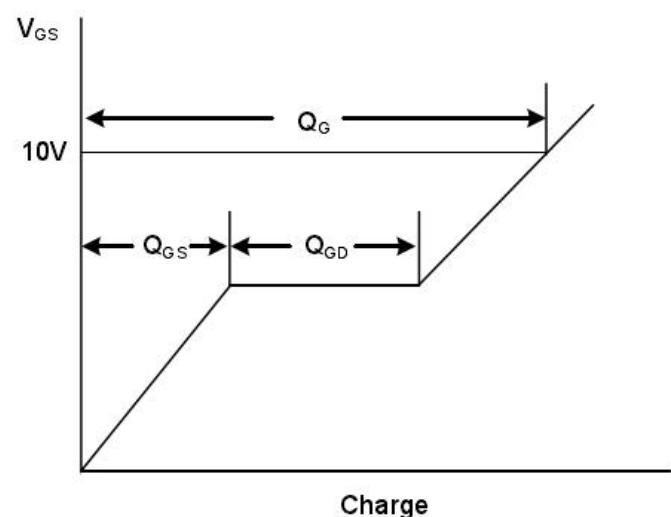
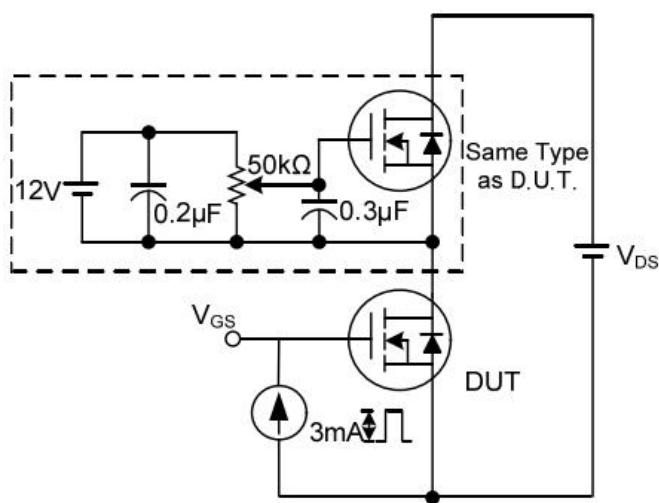


Peak Diode Recovery dv/dt Waveforms



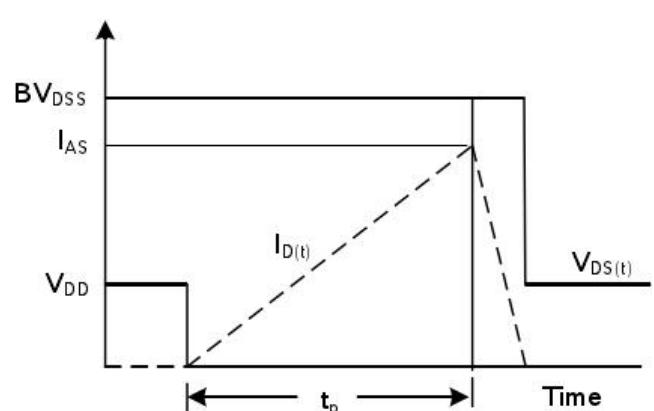
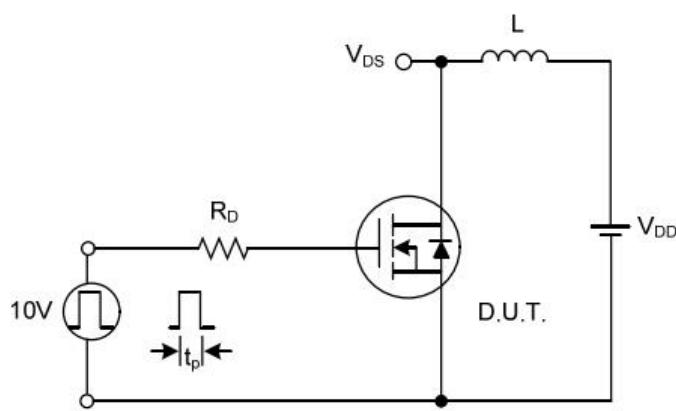
Switching Test Circuit

Switching Waveforms



Gate Charge Test Circuit

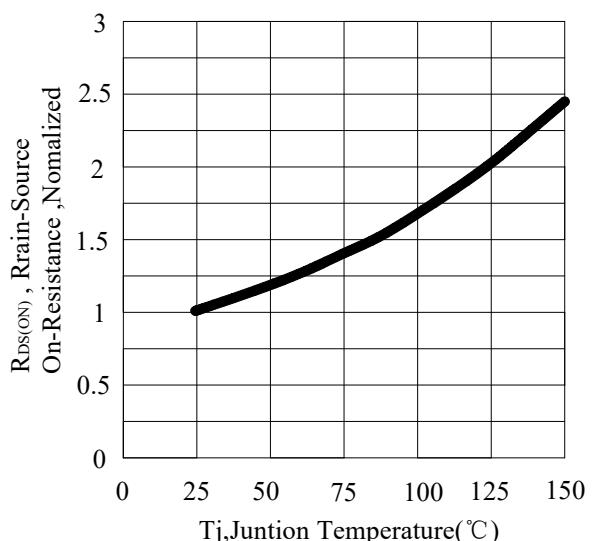
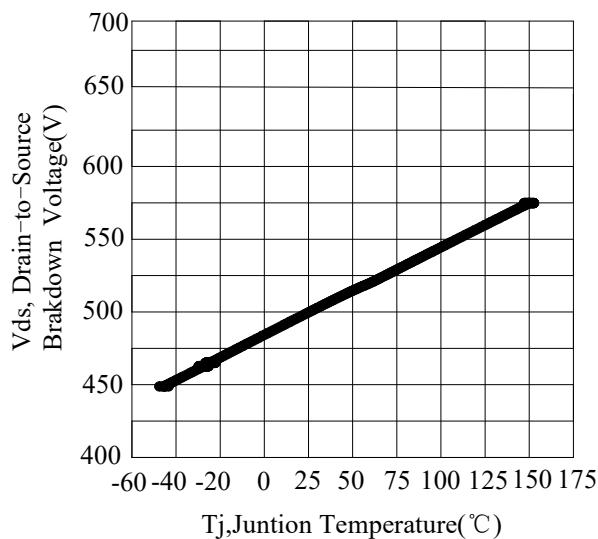
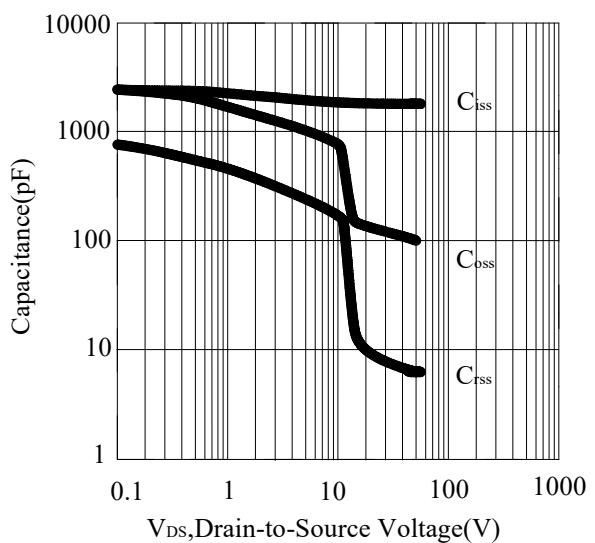
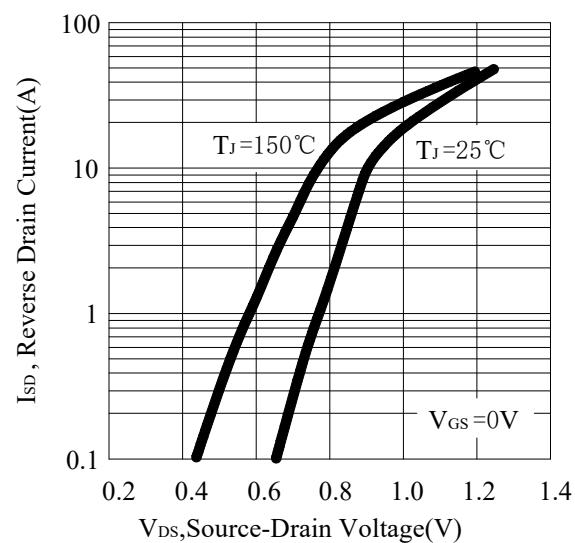
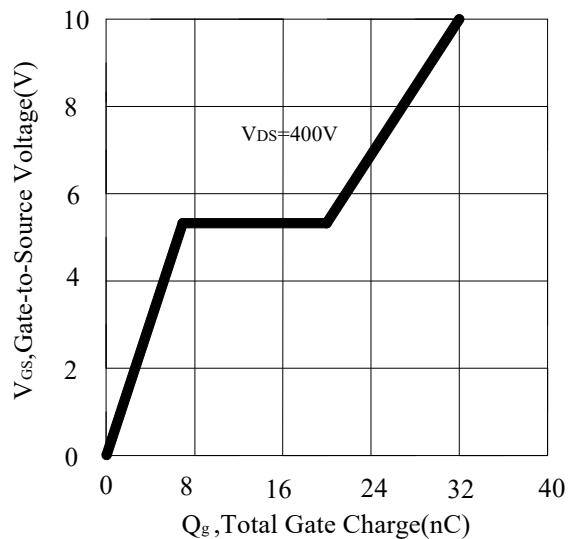
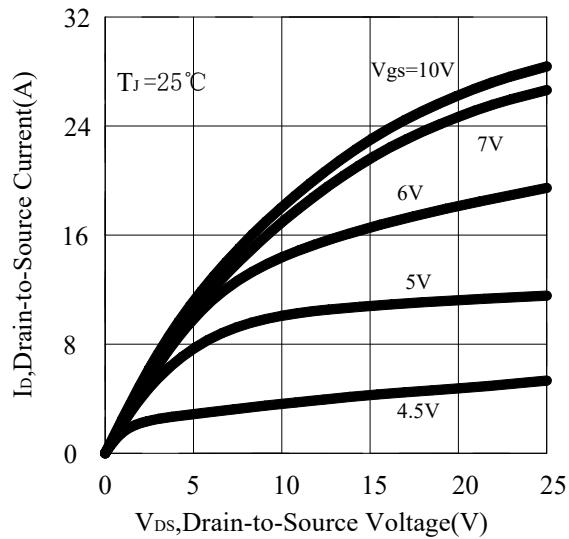
Gate Charge Waveform

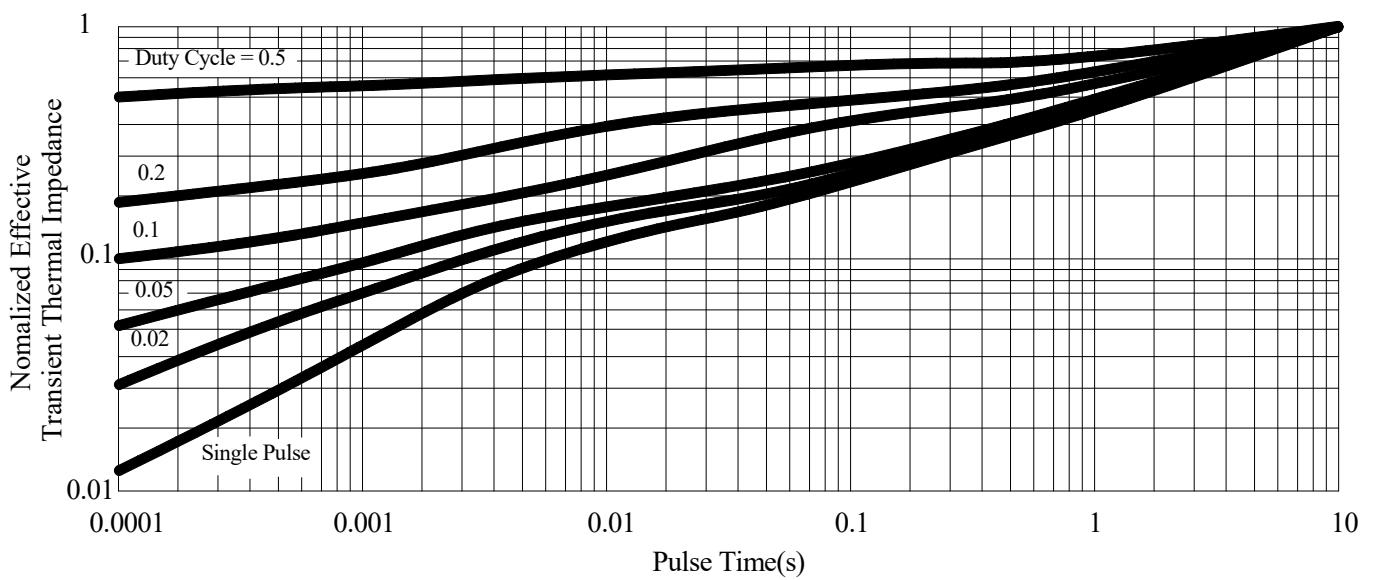
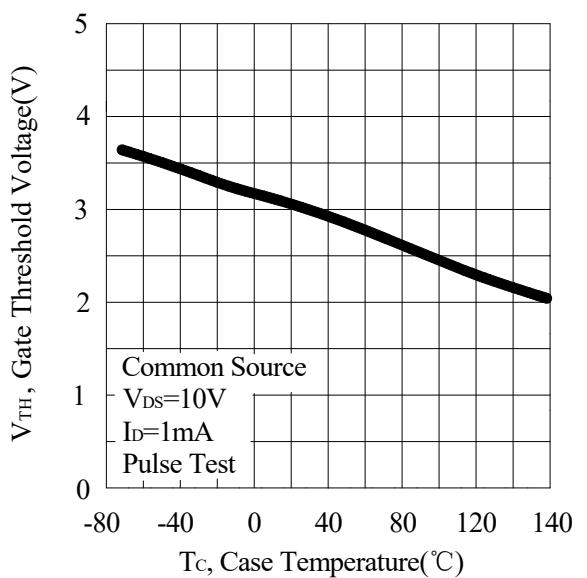
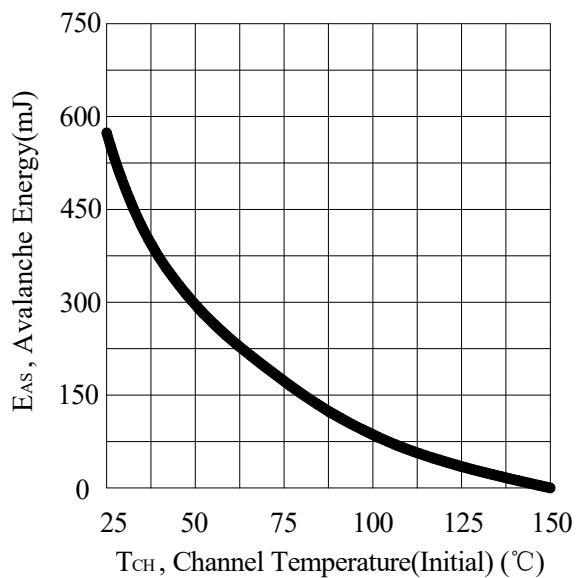
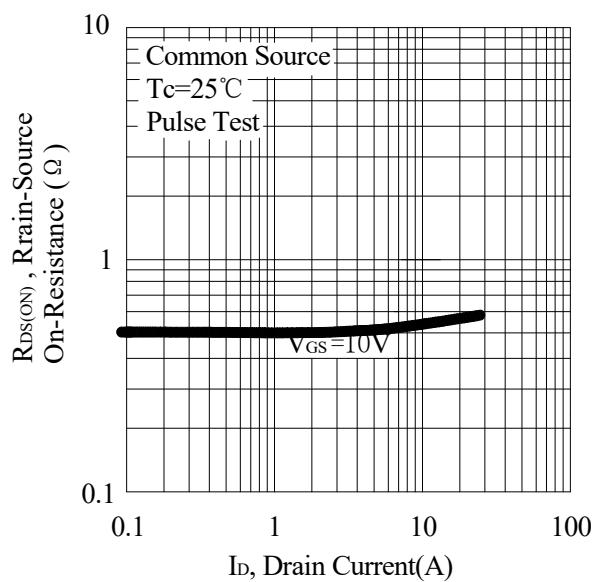
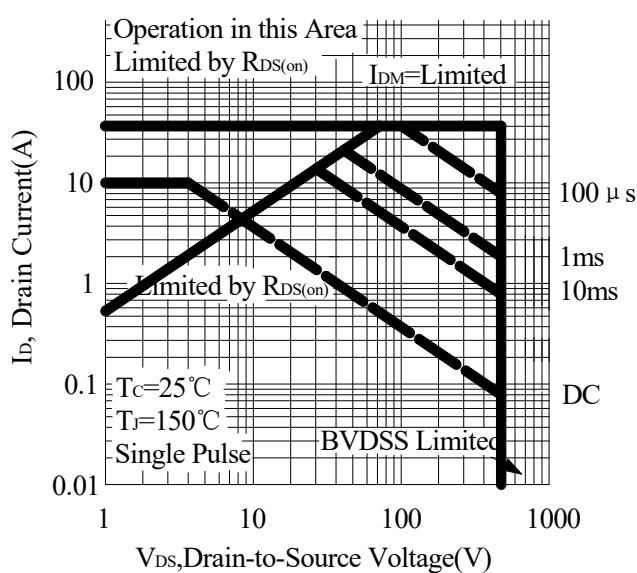


Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

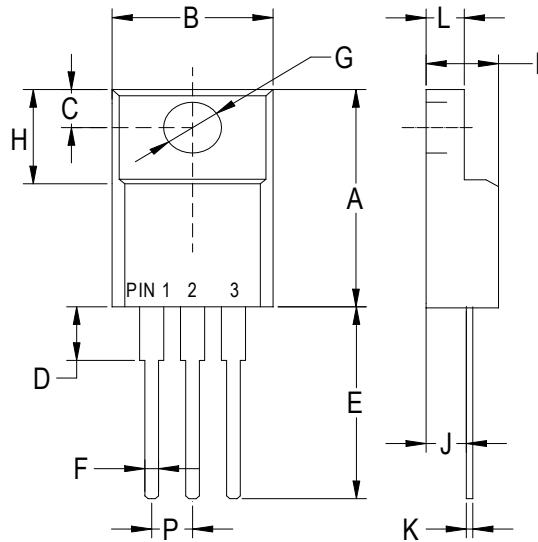
RATING AND CHARACTERISTIC CURVES





PACKAGE OUTLINE DIMENSIONS

TO-220TF



TO-220TF		
Dim	Min	Max
A	.590(15.0)	.650(16.5)
B	.393(10.0)	.414(10.5)
C	.118(3.00)	.138(3.50)
D	.118(3.00)	.146(3.70)
E	.512(13.0)	.551(14.0)
F	.028(0.70)	.035(0.90)
G	.114(2.90)	.138(3.50)
H	.255(6.50)	.280(7.10)
I	.173(4.40)	.197(5.00)
J	.102(2.60)	.110(2.80)
K	.018(0.45)	.026(0.65)
L	.092(2.35)	.109(2.75)
P	.890(2.25)	.113(2.85)